Specification Sheet for Approved

Customer Name:	
Customer Part No.:	
Ceaiya Part No:	MTC201210 Series
Spec No:	T2012

[For Customer Approval Only **]**

If you Approval, Please Stamp

[RoHS Compliant Parts]

Approved By	Checked By	Prepared By
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[Version	of Changed Record			
Rev.	Effective Date	Changed Contents	Change Reasons	Approved By
A0	2022-07-13	New release	/	Li qing hui





А	В	С	D	а	b	С
2.0±0.2	1.2±0.2	1.0Max	0.60±0.2	0.8~1.2	0.8~1.2	1.2~2.0

Specification Sheet for SMD Power Inductor

5.	Electrical Characteristics							
	Part Number	Inductance DC Saturation Resistance Current		DC Resistance		Heat Rating Current		
		1MHz/1V	Max.	Тур.	Max.	Тур.	Max.	Тур.
	Units	uH	Ω	Ω	А	A	A	A
	Symbol	L	DC	CR	ls	at	Irr	ns
	MTC201210-R47MT	0.47±20%	0.032	0.027	4.50	5.00	4.00	4.30
	MTC201210-R68MT	0.68±20%	0.046	0.038	3.60	4.30	3.00	3.50
	MTC201210-1R0MT	1.0±20%	0.056	0.046	3.40	3.80	2.90	3.30
	MTC201210-2R2MT	2.2±20%	0.166	0.140	2.00	2.20	1.50	1.70

Note: 1: Rated current: Isat(max.)or Irms(max.), whichever is smaller;

*2: Saturation Current: Max. Value, DC current at which the inductance drops less than 30% from its value without current; Typ. Value, DC current at which the inductance drops 30% from its value without current;

%3: Irms: DC current that causes the temperature rise ($\triangle T$) from 20 $^\circ C$ ambient.

For Max. Value, $\triangle T \le 40^{\circ}$ C; for Typ. Value, $\triangle T$ is approximate 40° C.

The part temperature (ambient + temp. rise) should not exceed 125° C under worst case operating conditions. Circuit design, component placement, PCB trace size and thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.

%4:Absolute maximum voltage:DC 20V

6. Structure

The structure of MTC201210 product.





NO.	Components	Material
1	Core	Soft magnetic Metal
2	Wire	Polyurethane system enameled copper wire
3-1		Inside Cu
3-2	Electrodes	Ni+Sn Plating Chemicals



△f: Clearance between terminal and the surface of plate must be 0.12mm max when coil is placed on a flat plate.

7.1 Bonding		It shall be soldered on the substrate
Strength		Applying Force(F): 10N Hold Duration: 5s
7.2 Ronding	Chip coil shall not be damaged.	Substrate: Glass-epoxy substrate
Strength		(100×40×1.0mm)
5		Speed of Applying Force: 0.5mm / s
		Deflection: 2mm
		Hold Duration: 20s Pressing device ↓ ① 加圧治具 R340 ▲ 訪科 □ Specimen 45 ⁴² → 45 ⁴²
7.3	No visible mechanical damage.	1) Solder the inductor to the testing jig (glass epoxy
Vibration	Inductance change: Within \pm 10%	board) using eutectic solder.
	Cu pad Solder mask	 a) The inductor shall be subjected to a simple namon motion having total amplitude of 1.5mm, the frequency being varied uniformly between the approximate limits of 10 and 55Hz. 3) The frequency range from 10 to 55Hz and return to 10Hz shall be traversed in approximately 1 minute. this motion shall be applied for a period of 2 hours in each 3mutually perpendicular directions (total of 6 hours).
7.4	The wetting area of the electrode shall	Flux:Ethanol solution of rosin,25(wt)%
Solderability	be at least 90% covered with new	Solder : Sn-3.0Ag-0.5Cu
	solder coating.	Pre-Heating:150±10°C / 60 to 90s
		Solder Temperature:245±5°C
		Immersion Time:3 s
7.5	Appearance:No damage	Reflow soldering method
Resistance to	Inductance Change : within ±10%	Flux: Ethanol solution of rosin,25(wt)%
Soldering		Solder: Sn-3.0Ag-0.5Cu
ιτσαι		Pre-Heating: 150 to 180°C / 60 to 120s
		Solder Temperature: 230°C min. / 20 to 40s
		Peak Temperature: 250+5/-0°C
		Reflow times: 2 times max
		Test board shall be 0.8 mm thick. Base material shall
		be glass epoxy resin.

Items	Requirements	Test Methods and Remarks
7.6		Temperature: 125±2°C
Heat		Time: 500h (±12h)
Resistance		Then measured after exposure Standard atmospheric conditions for 1~2h.
7.7 Cold		Temperature: -40±2°C Time: 500h (±12h)
Resistance		Then measured after exposure Standard atmospheric
		conditions for 1~2h.
7.8	Appearance:No damage Inductance Change : within +10%	Temperature: 40±2°C
Humidity		Humidity: 90 to 95%(RH)
-		Time: 500h (±12h)
		Then measured after
7.9	-	1 cycle:
Temperature		1 step: -40±2°C / 30±3m
Cycle		2 step: Ordinary temp. / 3m max.
		3 step: +125±2°C / 30±3m
		4 step: Ordinary temp. / 3m max.
		Total of 100 cycles
		Then measured after exposure Standard atmospheric
		conditions for 1~2h.

8. Packaging and Marking: 8-1.Carrier Tape Dimensions: DO Ρ2 Е P0 \bigcirc Μ $\overline{\Omega}$ AO ITEM P0 P2 W A0 B0 K0 Ρ F Е D0 Т DIM 8.00 1.3 2.3 1.10 4.00 3.5 1.75 1.50 4.00 2.00 0.20

+0.1

±0.1

±0.1

±0.05

8-2. Taping Dimensions:

±0.3

±0.1

±0.1

±0.1

±0.1

±0.1

±0.1

TOLE

